



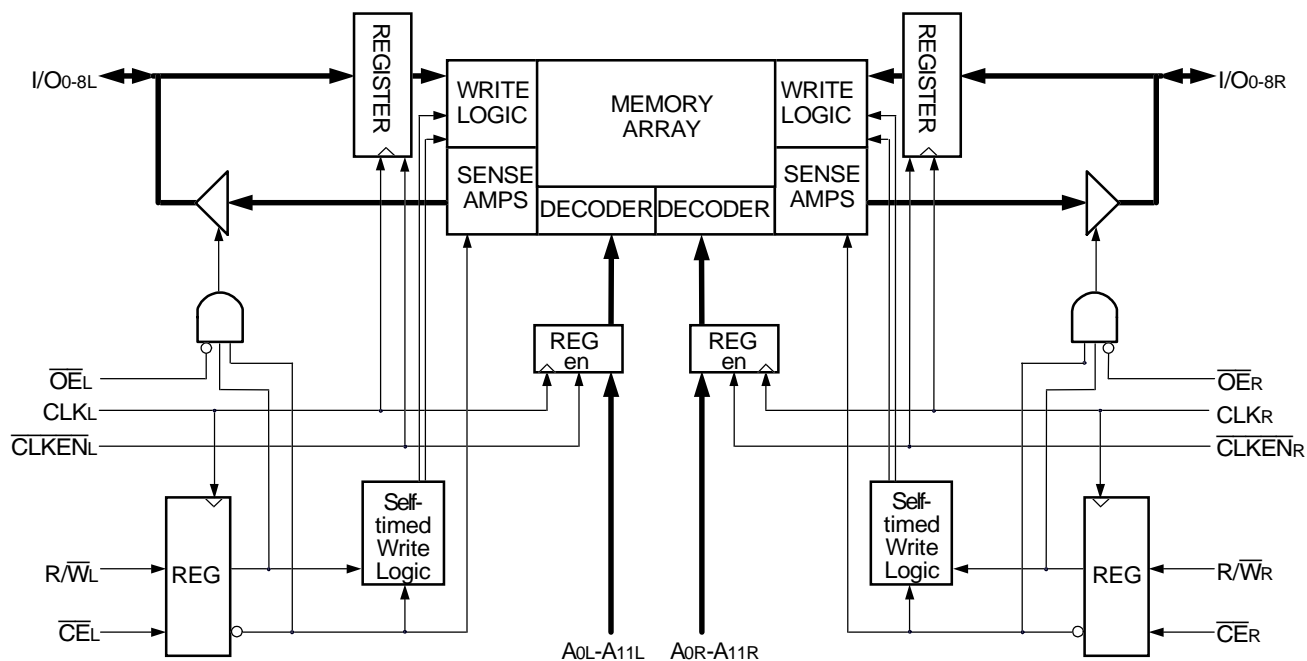
HIGH SPEED 36K (4K X 9) SYNCHRONOUS DUAL-PORT RAM

IDT70914S

Features

- ♦ **High-speed clock-to-data output times**
 - Military: 20/25ns (max.)
 - Commercial: 12/15/20ns (max.)
- ♦ **Low-power operation**
 - IDT70914S
 - Active: 850 mW (typ.)
 - Standby: 50 mW (typ.)
- ♦ **Architecture based on Dual-Port RAM cells**
 - Allows full simultaneous access from both ports
- ♦ **Synchronous operation**
 - 4ns setup to clock, 1ns hold on all control, data, and address inputs
 - Data input, address, and control registers
- Fast 12ns clock to data out
- Self-timed write allows fast cycle times
- 17ns cycle times, 58MHz operation
- ♦ **TTL-compatible, single 5V ($\pm 10\%$) power supply**
- ♦ **Clock Enable feature**
- ♦ **Guaranteed data output hold times**
- ♦ **Available in 68-pin PGA, PLCC, and 80-pin TQFP**
- ♦ **Military product compliant to MIL-PRF-38535 QML**
- ♦ **Industrial temperature range (-40°C to +85°C) is available for selected speeds.**
- ♦ **Recommended for replacement of IDT7099 (4K x 9) if separate 9th bit data control signals are not required.**

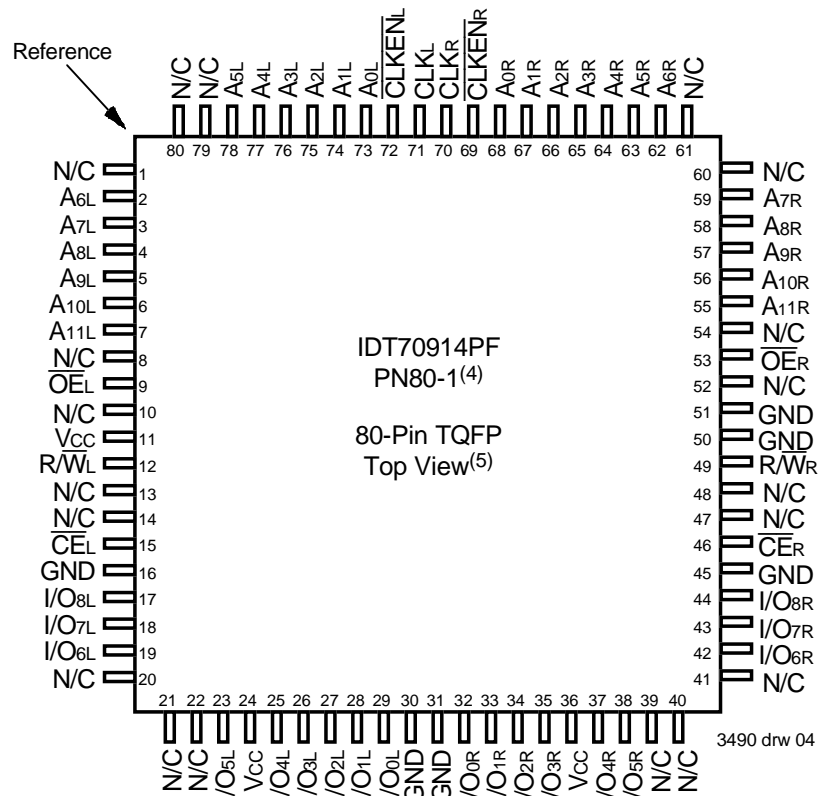
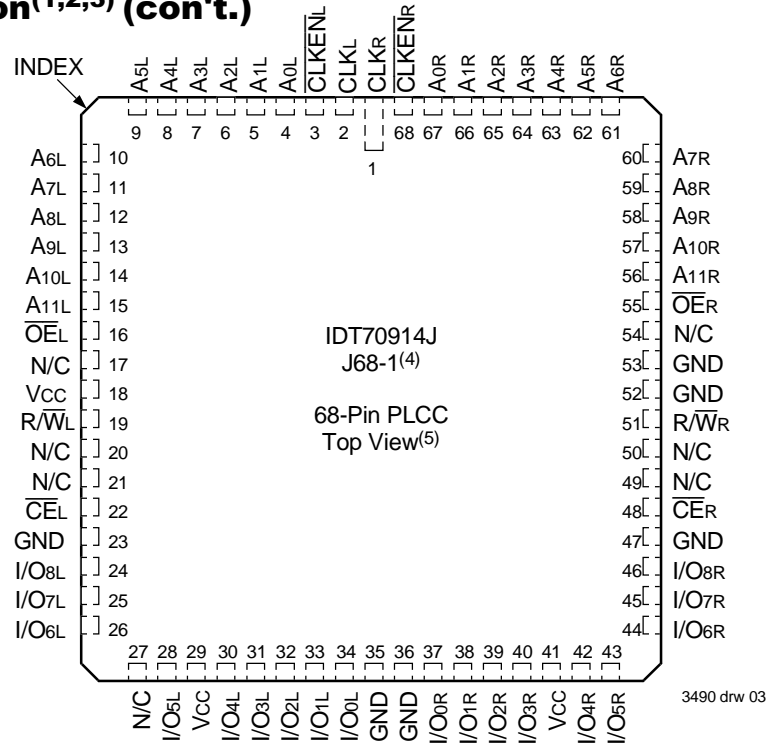
Functional Block Diagram



3490 drw 01

JUNE 1999

Pin Configuration^(1,2,3) (con't.)



NOTES:

1. All Vcc pins must be connected to power supply.
2. All ground pins must be connected to ground supply.
3. J68-1 package body is approximately .95 in x .95 in x .17 in.
PN80-1 package body is approximately 14mm x 14mm x 1.4mm.
4. This package code is used to reference the package diagram.
5. This text does not indicate orientation of the actual part-marking.

Absolute Maximum Ratings⁽¹⁾

Symbol	Rating	Commercial & Industrial	Military	Unit
$V_{TERM}^{(2)}$	Terminal Voltage with Respect to GND	-0.5 to +7.0	-0.5 to +7.0	V
$V_{TERM}^{(2)}$	Terminal Voltage	-0.5 to V_{CC}	-0.5 to V_{CC}	V
T_{BIAS}	Temperature Under Bias	-55 to +125	-65 to +135	°C
T_{STG}	Storage Temperature	-55 to +125	-65 to +150	°C
I_{OUT}	DC Output Current	50	50	mA

3490 tbl 01

NOTES:

- Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
- V_{TERM} must not exceed $V_{CC} + 10\%$ for more than 25% of the cycle time or 10ns maximum, and is limited to $\leq 20mA$ for the period of $V_{TERM} \geq V_{CC} + 10\%$.

Capacitance**($T_A = +25^\circ C$, $f = 1.0MHz$) TQFP Only**

Symbol	Parameter	Conditions	Max.	Unit
C_{IN}	Input Capacitance	$V_{IN} = 3dV$	8	pF
C_{OUT}	Output Capacitance	$V_{OUT} = 3dV$	9	pF

3490 tbl 04

NOTES:

- These parameters are determined by device characterization, but are not production tested.
- 3dV references the interpolated capacitance when the input and output switch from 0V to 3V or from 3V to 0V.

Maximum Operating Temperature and Supply Voltage^(1,2)

Grade	Ambient Temperature	GND	V_{CC}
Military	-55°C to +125°C	0V	$5.0V \pm 10\%$
Commercial	0°C to +70°C	0V	$5.0V \pm 10\%$
Industrial	-40°C to +85°C	0V	$5.0V \pm 10\%$

3490 tbl 02

NOTES:

- This is the parameter T_A .
- Industrial temperature: for specific speeds, packages and powers contact your

Recommended DC Operating Conditions

Symbol	Parameter	Min.	Typ.	Max.	Unit
V_{CC}	Supply Voltage	4.5	5.0	5.5	V
GND	Ground	0	0	0	V
V_{IH}	Input High Voltage	2.2	—	$6.0^{(2)}$	V
V_{IL}	Input Low Voltage	-0.5 ⁽¹⁾	—	0.8	V

3490 tbl 03

NOTES:

- $V_{IL} \geq -1.5V$ for pulse width less than 10ns.
- V_{TERM} must not exceed $V_{CC} + 10\%$.

DC Electrical Characteristics Over the Operating Temperature and Supply Voltage Range ($V_{CC} = 5.0V \pm 10\%$)

Symbol	Parameter	Test Conditions	70914S		Unit
			Min.	Max.	
$ I_{LI} $	Input Leakage Current ⁽¹⁾	$V_{CC} = 5.5V$, $V_{IN} = 0V$ to V_{CC}	—	10	μA
$ I_{LO} $	Output Leakage Current	$\overline{CE} = V_{IH}$, $V_{OUT} = 0V$ to V_{CC}	—	10	μA
V_{OL}	Output Low Voltage	$I_{OL} = +4mA$	—	0.4	V
V_{OH}	Output High Voltage	$I_{OH} = -4mA$	2.4	—	V

3490 tbl 05

NOTE:

- At $V_{CC} \leq 2.0V$, input leakages are undefined

DC Electrical Characteristics Over the Operating Temperature and Supply Voltage Range^(4,5) ($V_{CC} = 5V \pm 10\%$)

Symbol	Parameter	Test Condition	Version	70914S12 Com'l Only		70914S15 Com'l Only		Unit
				Typ. ⁽²⁾	Max.	Typ. ⁽²⁾	Max.	
I _{CC}	Dynamic Operating Current (Both Ports Active)	$\overline{CE_L}$ and $\overline{CE_R} = V_{IL}$, Outputs Open $f = f_{MAX}^{(1)}$	COM'L	190	310	180	300	mA
			MIL & IND	—	—	—	—	
I _{SB1}	Standby Current (Both Ports - TTL Level Inputs)	$\overline{CE_L}$ and $\overline{CE_R} = V_{IH}$ $f = f_{MAX}^{(1)}$	COM'L	95	150	90	140	mA
			MIL & IND	—	—	—	—	
I _{SB2}	Standby Current (One Port - TTL Level Inputs)	$\overline{CE}^*A = V_{IL}$ and $\overline{CE}^*B = V_{IH}^{(3)}$ Active Port Outputs Open, $f = f_{MAX}^{(1)}$	COM'L	170	220	160	210	mA
			MIL & IND	—	—	—	—	
I _{SB3}	Full Standby Current (Both Ports - All CMOS Level Inputs)	Both Ports $\overline{CE_R}$ and $\overline{CE_L} \geq V_{CC} - 0.2V$ $V_{IN} \geq V_{CC} - 0.2V$ or $V_{IN} \leq 0.2V$, $f = 0^{(2)}$	COM'L	10	15	10	15	mA
			MIL & IND	—	—	—	—	
I _{SB4}	Full Standby Current (One Port - All CMOS Level Inputs)	$\overline{CE}^*A \leq 0.2V$ and $\overline{CE}^*B \geq V_{CC} - 0.2V^{(3)}$ $V_{IN} \geq V_{CC} - 0.2V$ or $V_{IN} \leq 0.2V$, Active Port Outputs Open $f = f_{MAX}^{(1)}$	COM'L	165	210	155	200	mA
			MIL & IND	—	—	—	—	

3490 tbl 06a

Symbol	Parameter	Test Condition	Version	70914S20 Com'l & Military		70914S25 Military Only		Unit
				Typ. ⁽²⁾	Max.	Typ. ⁽²⁾	Max.	
I _{CC}	Dynamic Operating Current (Both Ports Active)	$\overline{CE_L}$ and $\overline{CE_R} = V_{IL}$, Outputs Open $f = f_{MAX}^{(1)}$	COM'L	170	290	—	—	mA
			MIL & IND	170	310	160	290	
I _{SB1}	Standby Current (Both Ports - TTL Level Inputs)	$\overline{CE_L}$ and $\overline{CE_R} = V_{IH}$ $f = f_{MAX}^{(1)}$	COM'L	85	130	—	—	mA
			MIL & IND	85	140	80	130	
I _{SB2}	Standby Current (One Port - TTL Level Inputs)	$\overline{CE}^*A = V_{IL}$ and $\overline{CE}^*B = V_{IH}^{(3)}$ Active Port Outputs Open, $f = f_{MAX}^{(1)}$	COM'L	150	200	—	—	mA
			MIL & IND	150	210	140	200	
I _{SB3}	Full Standby Current (Both Ports - All CMOS Level Inputs)	Both Ports $\overline{CE_R}$ and $\overline{CE_L} \geq V_{CC} - 0.2V$ $V_{IN} \geq V_{CC} - 0.2V$ or $V_{IN} \leq 0.2V$, $f = 0^{(2)}$	COM'L	10	15	—	—	mA
			MIL & IND	10	20	10	20	
I _{SB4}	Full Standby Current (One Port - All CMOS Level Inputs)	$\overline{CE}^*A \leq 0.2V$ and $\overline{CE}^*B \geq V_{CC} - 0.2V^{(3)}$ $V_{IN} \geq V_{CC} - 0.2V$ or $V_{IN} \leq 0.2V$, Active Port Outputs Open $f = f_{MAX}^{(1)}$	COM'L	145	190	—	—	mA
			MIL & IND	145	200	135	190	

NOTES:

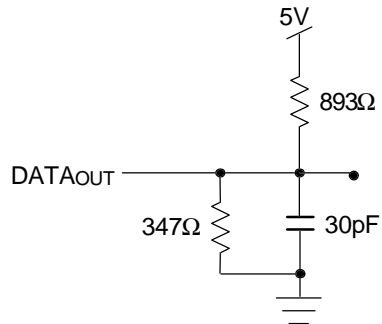
3490 tbl 06b

- At f_{MAX} , address and control lines (except Output Enable) are cycling at the maximum frequency clock cycle of $1/t_{CYC}$, using "AC TEST CONDITIONS" at input levels of GND to 3V.
- $f = 0$ means no address, clock, or control lines change. Applies only to input at CMOS level standby.
- Port "A" may be either left or right port. Port "B" is the opposite from port "A".
- $V_{CC} = 5V$, $T_A = 25^\circ C$ for Typ, and are not production tested. $I_{CC DC} = 150mA$ (Typ).
- Industrial temperature: for specific speeds, packages and powers contact your sales office.

AC Test Conditions

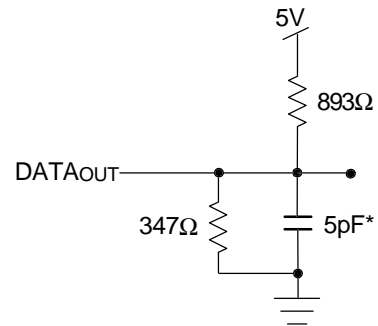
Input Pulse Levels	GND to 3.0V
Input Rise/Fall Times	3ns Max.
Input Timing Reference Levels	1.5V
Output Reference Levels	1.5V
Output Load	Figures 1,2 and 3

3490 tbl 07



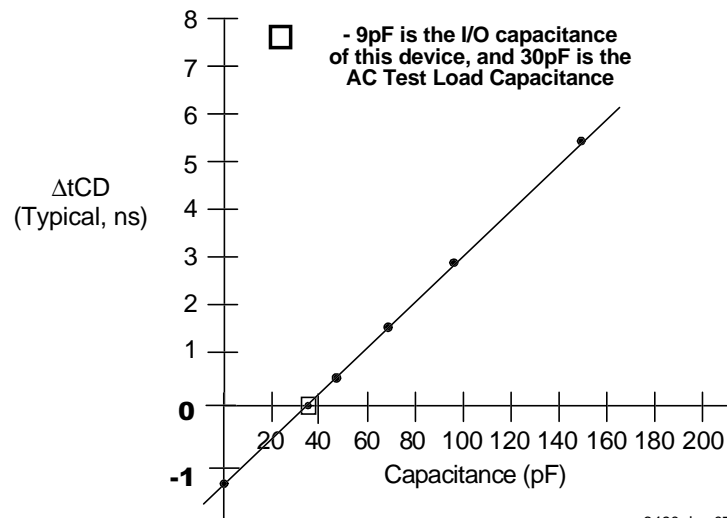
3490 drw 05

Figure 1. AC Output Test load.



3490 drw 06

Figure 2. Output Test Load
 (For tCKLZ, tCKHZ, tOLZ, and tOHZ).
 *Including scope and jig.



3490 drw 07

Figure 3. Typical Output Derating (Lumped Capacitive Load).

AC Electrical Characteristics Over the Operating Temperature Range (Read and Write Cycle Timing)⁽³⁾

(Commercial: $V_{CC} = 5V \pm 10\%$, $T_A = 0^\circ C$ to $+70^\circ C$; Military: $V_{CC} = 5V \pm 10\%$, $T_A = -55^\circ C$ to $+125^\circ C$)

Symbol	Parameter	70914S12 Com'l Only		70914S15 Com'l Only		Unit
		Min.	Max.	Min.	Max.	
t _{CYC}	Clock Cycle Time	17	—	20	—	ns
t _{CH}	Clock High Time	6	—	6	—	ns
t _{CL}	Clock Low Time	6	—	6	—	ns
t _{CD}	Clock High to Output Valid	—	12	—	15	ns
t _S	Registered Signal Set-up Time	4	—	4	—	ns
t _H	Registered Signal Hold Time	1	—	1	—	ns
t _{DC}	Data Output Hold After Clock High	3	—	3	—	ns
t _{CKLZ}	Clock High to Output Low-Z ^(1,2)	2	—	2	—	ns
t _{CKHZ}	Clock High to Output High-Z ^(1,2)	—	7	—	7	ns
t _{OE}	Output Enable to Output Valid	—	7	—	8	ns
t _{OLZ}	Output Enable to Output Low-Z ^(1,2)	0	—	0	—	ns
t _{OHZ}	Output Disable to Output High-Z ^(1,2)	—	7	—	7	ns
t _{SECK}	Clock Enable, Disable Set-up Time	4	—	4	—	ns
t _{HECK}	Clock Enable, Disable Hold Time	2	—	2	—	ns
Port-to-Port Delay						
t _{CWDD}	Write Port Clock High to Read Data Delay	—	25	—	30	ns
t _{CSS}	Clock-to-Clock Setup Time	—	13	—	15	ns

3490 tbl 08a

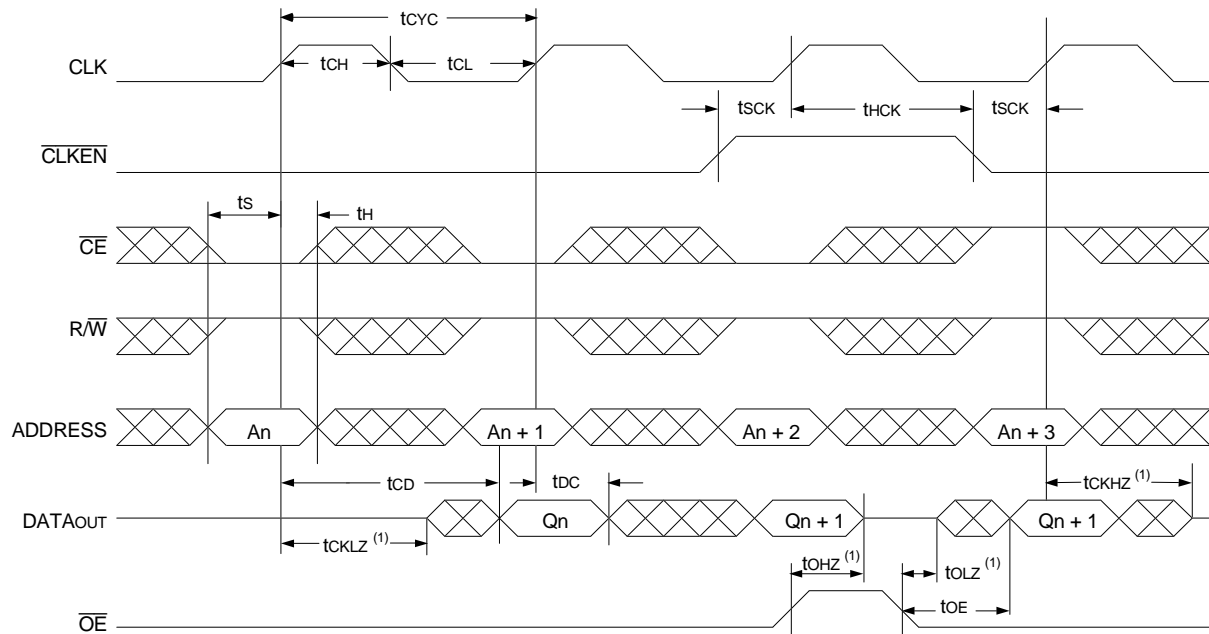
Symbol	Parameter	70914S20 Com'l & Military		70914S25 Military Only		Unit
		Min.	Max.	Min.	Max.	
t _{CYC}	Clock Cycle Time	20	—	25	—	ns
t _{CH}	Clock High Time	8	—	10	—	ns
t _{CL}	Clock Low Time	8	—	10	—	ns
t _{CD}	Clock High to Output Valid	—	20	—	25	ns
t _S	Registered Signal Set-up Time	5	—	6	—	ns
t _H	Registered Signal Hold Time	1	—	1	—	ns
t _{DC}	Data Output Hold After Clock High	3	—	3	—	ns
t _{CKLZ}	Clock High to Output Low-Z ^(1,2)	2	—	2	—	ns
t _{CKHZ}	Clock High to Output High-Z ^(1,2)	—	9	—	12	ns
t _{OE}	Output Enable to Output Valid	—	10	—	12	ns
t _{OLZ}	Output Enable to Output Low-Z ^(1,2)	0	—	0	—	ns
t _{OHZ}	Output Disable to Output High-Z ^(1,2)	—	9	—	11	ns
t _{SECK}	Clock Enable, Disable Set-up Time	5	—	6	—	ns
t _{HECK}	Clock Enable, Disable Hold Time	2	—	2	—	ns
Port-to-Port Delay						
t _{CWDD}	Write Port Clock High to Read Data Delay	—	35	—	45	ns
t _{CSS}	Clock-to-Clock Setup Time	—	15	—	20	ns

3490 tbl 08b

NOTES:

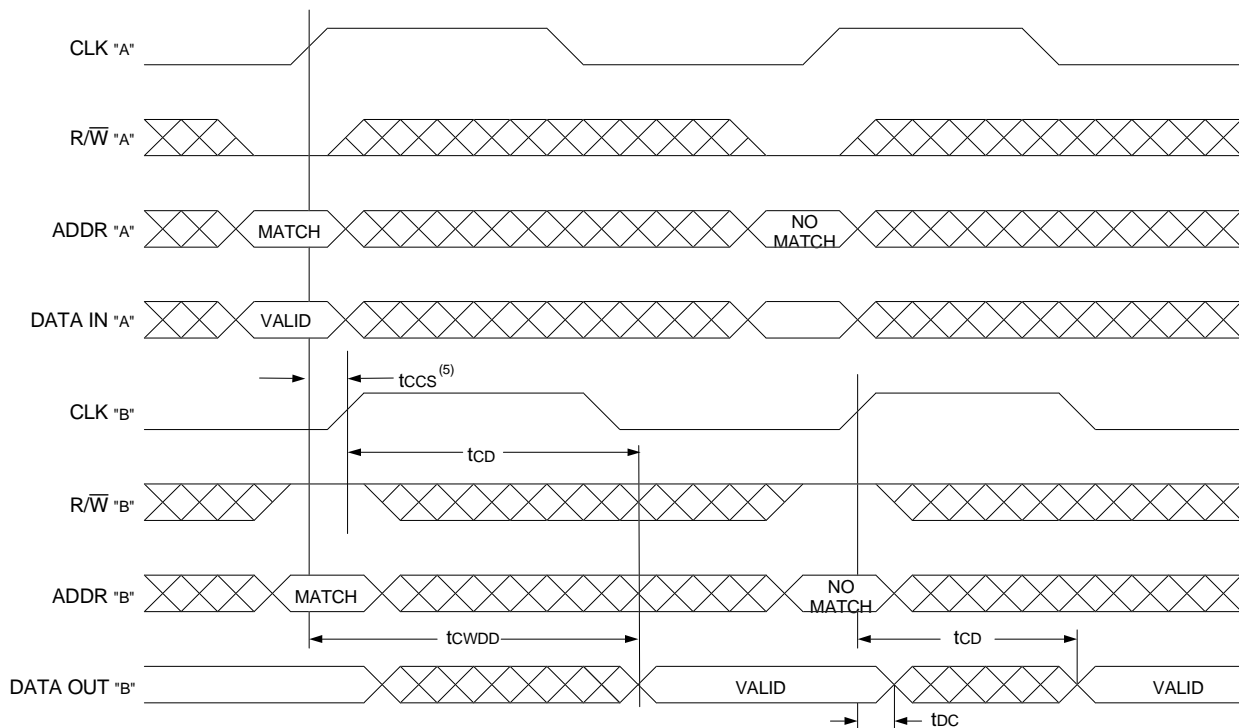
1. Transition is measured $\pm 200mV$ from Low or High impedance voltage with the Output Test Load (Figure 2).
2. This parameter is guaranteed by device characterization, but is not production tested.
3. Industrial temperature: for specific speeds, packages and powers contact your sales office.

Timing Waveform of Read Cycle, Either Side



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Timing Waveform of Write with Port-to-Port Read^(2,3,4)

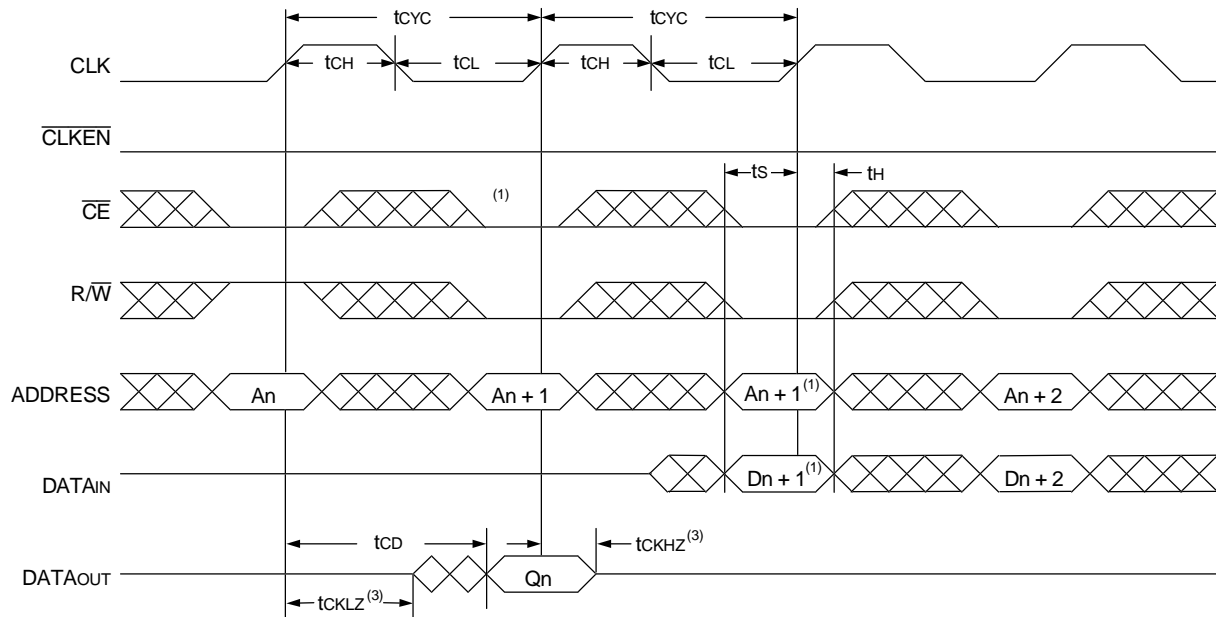


3490 drw 09

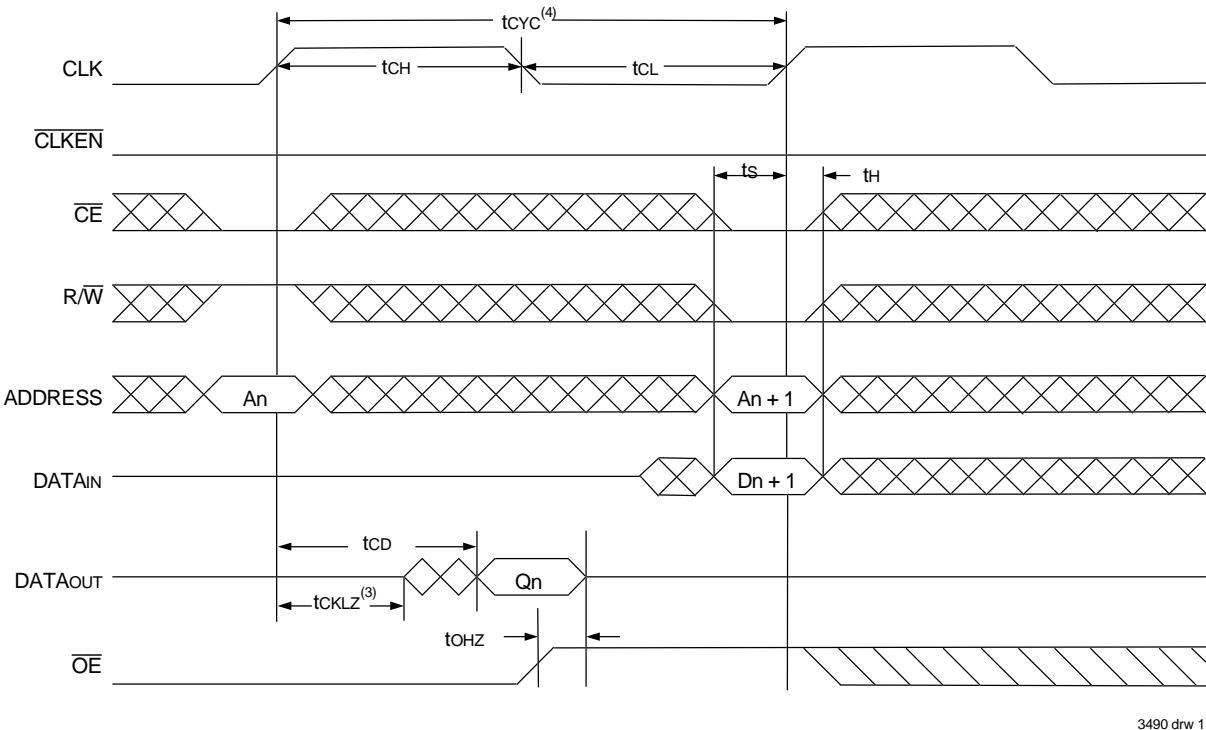
NOTES:

1. Transition is measured $\pm 200\text{mV}$ from Low or High-impedance voltage with the Output Test Load (Figure 2).
2. $\overline{\text{CE}}_{\text{L}} = \overline{\text{CE}}_{\text{R}} = V_{\text{IL}}$, $\overline{\text{CLKEN}}_{\text{L}} = \overline{\text{CLKEN}}_{\text{R}} = V_{\text{IL}}$.
3. $\overline{\text{OE}} = V_{\text{IL}}$ for the reading port, port 'B'.
4. All timing is the same for left and right ports. Ports 'A' may be either the left or right port. Port 'B' is opposite from port 'A'.
5. If $t_{\text{CCS}} \leq$ maximum specified, then data from right port READ is not valid until the maximum specified for t_{CWD} .
If $t_{\text{CCS}} >$ maximum specified, then data from right port READ is not valid until $t_{\text{CCS}} + t_{\text{CD}}$. t_{CWD} does not apply in this case.

Timing Waveform of Read-to-Write Cycle No. 1^(1,2) ($t_{CYC} = \text{min.}$)



Timing Waveform of Read-to-Write Cycle No. 2⁽⁴⁾ ($t_{CYC} > \text{min.}$)



NOTES:

1. For $t_{CYC} = \text{min.}$; data out coincident with the rising edge of the subsequent write clock can occur. To ensure writing to the correct address location, the write must be repeated on the second write clock rising edge. If $\overline{CE} = V_{IL}$, invalid data will be written into array. The $An+1$ must be rewritten on the following cycle.
2. \overline{OE} LOW throughout.
3. Transition is measured $\pm 200\text{mV}$ from Low or High-impedance voltage with the Output Test Load (Figure 2).
4. For $t_{CYC} > \text{min.}$; \overline{OE} may be used to avoid data out coincident with the rising edge of the subsequent write clock. Use of \overline{OE} will eliminate the need for the write to be repeated.

Functional Description

The IDT70914 provides a true synchronous Dual-Port Static RAM interface. Registered inputs provide very short set-up and hold times on address, data, and all critical control inputs. All internal registers are clocked on the rising edge of the clock signal. An asynchronous output enable is provided to ease asynchronous bus interfacing.

The internal write pulse width is dependent on the LOW to HIGH

transitions of the clock signal allowing the shortest possible realized cycle times. Clock enable inputs are provided to stall the operation of the address and data input registers without introducing clock skew for very fast interleaved memory applications.

A HIGH on the \overline{CE} input for one clock cycle will power down the internal circuitry to reduce static power consumption.

Truth Table I: Read/Write Control⁽¹⁾

Inputs				Outputs	Mode
Synchronous ⁽³⁾			Asynchronous		
CLK	\overline{CE}	$R\overline{W}$	\overline{OE}	I/O ₀₋₈	
↑	H	X	X	High-Z	Deselected, Power-Down
↑	L	L	X	DATA _{IN}	Selected and Write Enabled
↑	L	H	L	DATA _{OUT}	Read Selected and Data Output Enable Read
↑	X	X	H	High-Z	Outputs Disabled

3490 tbl 09

Truth Table II: Clock Enable Function Table⁽¹⁾

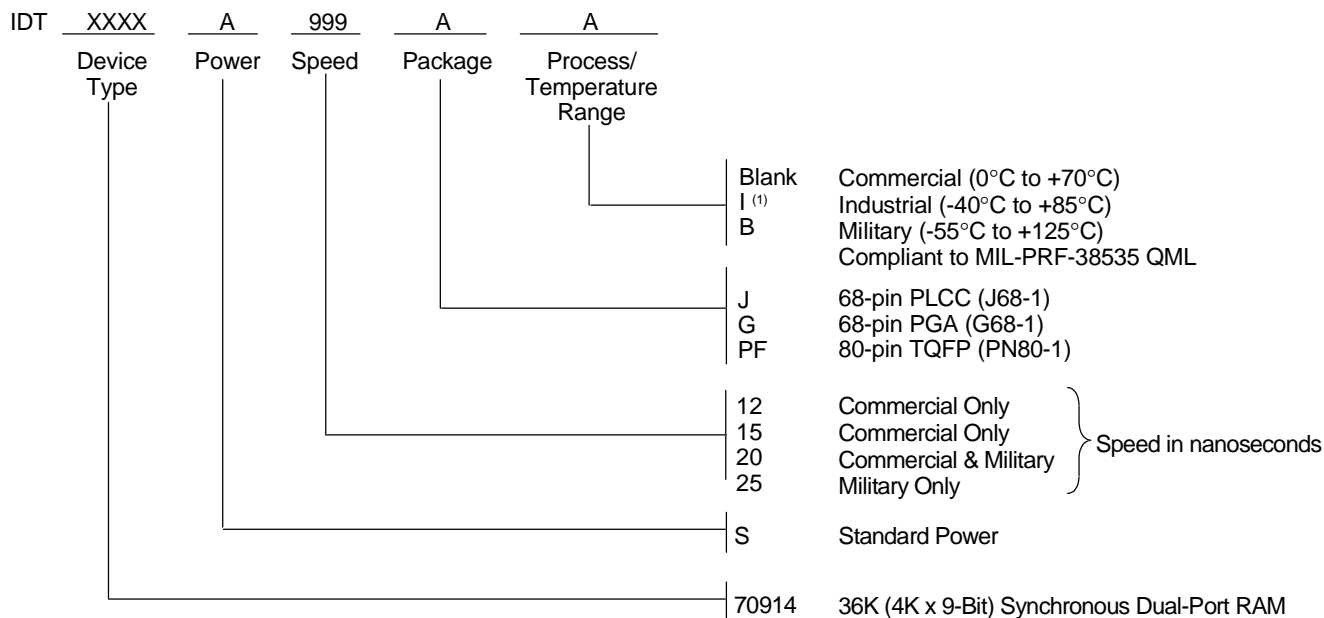
Mode	Inputs		Register Inputs		Register Outputs ⁽⁴⁾	
	CLK ⁽³⁾	\overline{CLKEN} ⁽²⁾	ADDR	DATA _{IN}	ADDR	DATA _{OUT}
Load "1"	↑	L	H	H	H	H
Load "0"	↑	L	L	L	L	L
Hold (do nothing)	↑	H	X	X	NC	NC
	X	H	X	X	NC	NC

3490 tbl 10

NOTES:

- 'H' = HIGH voltage level steady state, 'h' = HIGH voltage level one set-up time prior to the LOW-to-HIGH clock transition, 'L' = LOW voltage level steady state 'l' = LOW voltage level one set-up time prior to the LOW-to-HIGH clock transition, 'X' = Don't care, 'NC' = No change
- \overline{CLKEN} = V_{IL} must be clocked in during Power-Up.
- Control signals are initiated and terminated on the rising edge of the CLK, depending on their input level. When R/\overline{W} and \overline{CE} are LOW, a write cycle is initiated on the LOW-to-HIGH transition of the CLK. Termination of a write cycle is done on the next LOW-to-HIGH transition of the CLK.
- The register outputs are internal signals from the register inputs being clocked in or disabled by \overline{CLKEN} .

Ordering Information



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NOTE:

1. Industrial temperature range is available on selected TQFP packages in standard power.
 For specific speeds, packages and powers contact your sales office.

Datasheet Document History

- | | |
|----------|--|
| 3/10/99: | Initiated datasheet document history
Converted to new format
Cosmetic and typographical corrections
Page 2 and 3 Added additional notes to pin configurations |
| 6/7/99: | Changed drawing format |



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